

## N-channel 800 V, 0.95 $\Omega$ typ., 6 A MDmesh™ K5 Power MOSFETs in TO-220FP and I<sup>2</sup>PAKFP packages

Datasheet - production data

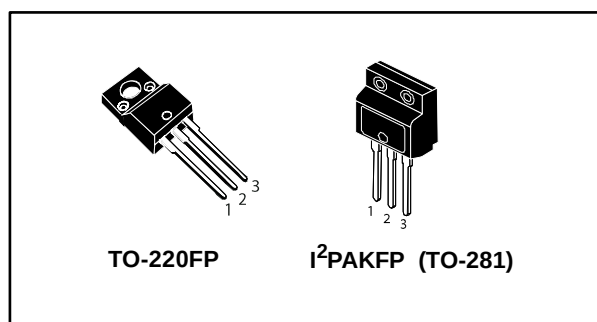
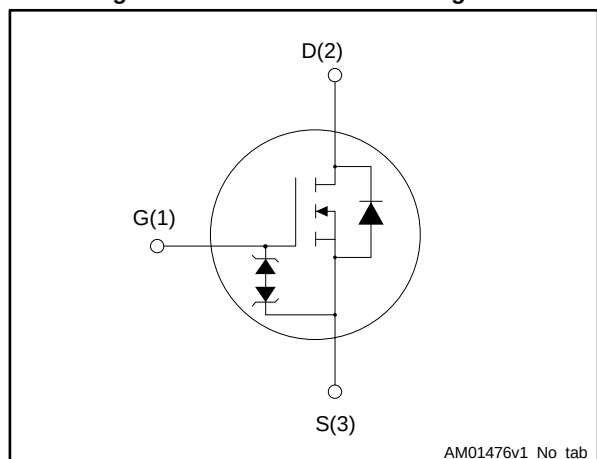


Figure 1: Internal schematic diagram



### Features

| Order code | V <sub>DS</sub> | R <sub>DS(on)</sub> max. | I <sub>D</sub> | P <sub>TOT</sub> |
|------------|-----------------|--------------------------|----------------|------------------|
| STF7N80K5  | 800 V           | 1.2 $\Omega$             | 6 A            | 25 W             |
| STFI7N80K5 |                 |                          |                |                  |

- Industry's lowest R<sub>DS(on)</sub> x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

### Applications

- Switching applications

### Description

These very high voltage N-channel Power MOSFETs are designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

| Order code | Marking | Package                       | Packing |
|------------|---------|-------------------------------|---------|
| STF7N80K5  | 7N80K5  | TO-220FP                      | Tube    |
| STFI7N80K5 |         | I <sup>2</sup> PAKFP (TO-281) |         |

---

## Contents

|          |                                                             |           |
|----------|-------------------------------------------------------------|-----------|
| <b>1</b> | <b>Electrical ratings .....</b>                             | <b>3</b>  |
| <b>2</b> | <b>Electrical characteristics .....</b>                     | <b>4</b>  |
|          | 2.1 Electrical characteristics (curves) .....               | 6         |
| <b>3</b> | <b>Test circuits .....</b>                                  | <b>9</b>  |
| <b>4</b> | <b>Package information .....</b>                            | <b>10</b> |
|          | 4.1 TO-220FP package information .....                      | 11        |
|          | 4.2 I <sup>2</sup> PAKFP (TO-281) package information ..... | 13        |
| <b>5</b> | <b>Revision history .....</b>                               | <b>15</b> |

# 1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol         | Parameter                                                                                                                         | Value       | Unit             |
|----------------|-----------------------------------------------------------------------------------------------------------------------------------|-------------|------------------|
| $V_{GS}$       | Gate-source voltage                                                                                                               | $\pm 30$    | V                |
| $I_D^{(1)}$    | Drain current (continuous) at $T_C = 25\text{ }^\circ\text{C}$                                                                    | 6           | A                |
| $I_D^{(1)}$    | Drain current (continuous) at $T_C = 100\text{ }^\circ\text{C}$                                                                   | 3.8         | A                |
| $I_{DM}^{(2)}$ | Drain current (pulsed)                                                                                                            | 24          | A                |
| $P_{TOT}$      | Total dissipation at $T_C = 25\text{ }^\circ\text{C}$                                                                             | 25          | W                |
| $dv/dt^{(3)}$  | Peak diode recovery voltage slope                                                                                                 | 4.5         | V/ns             |
| $dv/dt^{(4)}$  | MOSFET $dv/dt$ ruggedness                                                                                                         | 50          |                  |
| $V_{ISO}$      | Insulation withstand voltage (RMS) from all three leads to external heat sink ( $t=1\text{ s}$ ; $T_C=25\text{ }^\circ\text{C}$ ) | 2500        | V                |
| $T_j$          | Operating junction temperature range                                                                                              | - 55 to 150 | $^\circ\text{C}$ |
| $T_{stg}$      | Storage temperature range                                                                                                         |             |                  |

**Notes:**

(1)Limited by package.

(2)Pulse width limited by safe operating area

(3) $I_{SD} \leq 6\text{ A}$ ,  $di/dt \leq 100\text{ A}/\mu\text{s}$ ,  $V_{DS(peak)} \leq V_{(BR)DSS}$ (4) $V_{DS} \leq 640\text{ V}$ 

Table 3: Thermal data

| Symbol         | Parameter                           | Value | Unit                      |
|----------------|-------------------------------------|-------|---------------------------|
| $R_{thj-case}$ | Thermal resistance junction-case    | 5     | $^\circ\text{C}/\text{W}$ |
| $R_{thj-amb}$  | Thermal resistance junction-ambient | 62.5  | $^\circ\text{C}/\text{W}$ |

Table 4: Avalanche characteristics

| Symbol   | Parameter                                                                                                            | Value | Unit |
|----------|----------------------------------------------------------------------------------------------------------------------|-------|------|
| $I_{AR}$ | Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax}$ )                                 | 2     | A    |
| $E_{AS}$ | Single pulse avalanche energy (starting $T_j = 25\text{ }^\circ\text{C}$ , $I_D = I_{AR}$ , $V_{DD} = 50\text{ V}$ ) | 88    | mJ   |

## 2 Electrical characteristics

$T_C = 25\text{ }^{\circ}\text{C}$  unless otherwise specified

**Table 5: On/off-state**

| Symbol        | Parameter                         | Test conditions                                                                                       | Min. | Typ. | Max.     | Unit          |
|---------------|-----------------------------------|-------------------------------------------------------------------------------------------------------|------|------|----------|---------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage    | $V_{GS} = 0\text{ V}$ , $I_D = 1\text{ mA}$                                                           | 800  |      |          | V             |
| $I_{DSS}$     | Zero gate voltage drain current   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 800\text{ V}$                                                       |      |      | 1        | $\mu\text{A}$ |
|               |                                   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 800\text{ V}$<br>$T_C = 125\text{ }^{\circ}\text{C}$ <sup>(1)</sup> |      |      | 50       | $\mu\text{A}$ |
| $I_{GSS}$     | Gate body leakage current         | $V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 20\text{ V}$                                                    |      |      | $\pm 10$ | $\mu\text{A}$ |
| $V_{GS(th)}$  | Gate threshold voltage            | $V_{DD} = V_{GS}$ , $I_D = 100\text{ }\mu\text{A}$                                                    | 3    | 4    | 5        | V             |
| $R_{DS(on)}$  | Static drain-source on-resistance | $V_{GS} = 10\text{ V}$ , $I_D = 3\text{ A}$                                                           |      | 0.95 | 1.2      | $\Omega$      |

**Notes:**

<sup>(1)</sup>Defined by design, not subject to production test.

**Table 6: Dynamic**

| Symbol            | Parameter                             | Test conditions                                                                                                                                                 | Min. | Typ. | Max. | Unit     |
|-------------------|---------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|----------|
| $C_{iss}$         | Input capacitance                     | $V_{DS} = 100\text{ V}$ , $f = 1\text{ MHz}$ ,<br>$V_{GS} = 0\text{ V}$                                                                                         | -    | 360  | -    | pF       |
| $C_{oss}$         | Output capacitance                    |                                                                                                                                                                 | -    | 30   | -    | pF       |
| $C_{rss}$         | Reverse transfer capacitance          |                                                                                                                                                                 | -    | 1    | -    | pF       |
| $C_{o(tr)}^{(1)}$ | Equivalent capacitance time related   | $V_{DS} = 0\text{ to }640\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                                     | -    | 47   | -    | pf       |
| $C_{o(er)}^{(2)}$ | Equivalent capacitance energy related |                                                                                                                                                                 | -    | 20   | -    | pf       |
| $R_g$             | Intrinsic gate resistance             | $f = 1\text{ MHz}$ , $I_D = 0\text{ A}$                                                                                                                         | -    | 6    | -    | $\Omega$ |
| $Q_g$             | Total gate charge                     | $V_{DD} = 640\text{ V}$ , $I_D = 6\text{ A}$<br>$V_{GS} = 0\text{ to }10\text{ V}$<br>(see <a href="#">Figure 16: "Test circuit for gate charge behavior"</a> ) | -    | 13.4 | -    | nC       |
| $Q_{gs}$          | Gate-source charge                    |                                                                                                                                                                 | -    | 3.7  | -    | nC       |
| $Q_{gd}$          | Gate-drain charge                     |                                                                                                                                                                 | -    | 7.5  | -    | nC       |

**Notes:**

<sup>(1)</sup> $C_{o(tr)}$  is a constant capacitance value that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

<sup>(2)</sup> $C_{o(er)}$  is a constant capacitance value that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

Table 7: Switching times

| Symbol       | Parameter           | Test conditions                                                                                                                                                                                                                                 | Min. | Typ. | Max. | Unit |
|--------------|---------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $t_{d(on)}$  | Turn-on delay time  | $V_{DD} = 400\text{ V}$ , $I_D = 3\text{ A}$ ,<br>$R_G = 4.7\ \Omega$<br>$V_{GS} = 10\text{ V}$<br>(see <a href="#">Figure 15: "Test circuit for resistive load switching times"</a> and <a href="#">Figure 20: "Switching time waveform"</a> ) | -    | 11.3 | -    | ns   |
| $t_r$        | Rise time           |                                                                                                                                                                                                                                                 | -    | 8.3  | -    | ns   |
| $t_{d(off)}$ | Turn-off delay time |                                                                                                                                                                                                                                                 | -    | 23.7 | -    | ns   |
| $t_f$        | Fall time           |                                                                                                                                                                                                                                                 | -    | 20.2 | -    | ns   |

Table 8: Source-drain diode

| Symbol          | Parameter                     | Test conditions                                                                                                                                                                                                                   | Min. | Typ. | Max. | Unit          |
|-----------------|-------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|---------------|
| $I_{SD}$        | Source-drain current          |                                                                                                                                                                                                                                   | -    |      | 6    | A             |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) |                                                                                                                                                                                                                                   | -    |      | 24   | A             |
| $V_{SD}^{(2)}$  | Forward on voltage            | $I_{SD} = 6\text{ A}$ , $V_{GS} = 0\text{ V}$                                                                                                                                                                                     | -    |      | 1.5  | V             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 6\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ , $V_{DD} = 60\text{ V}$<br>(see <a href="#">Figure 17: "Test circuit for inductive load switching and diode recovery times"</a> )                                     | -    | 315  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       |                                                                                                                                                                                                                                   | -    | 2.8  |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |                                                                                                                                                                                                                                   | -    | 17.5 |      | A             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 6\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ , $V_{DD} = 60\text{ V}$ , $T_j = 150\text{ }^\circ\text{C}$<br>(see <a href="#">Figure 17: "Test circuit for inductive load switching and diode recovery times"</a> ) | -    | 480  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       |                                                                                                                                                                                                                                   | -    | 3.8  |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |                                                                                                                                                                                                                                   | -    | 16   |      | A             |

**Notes:**<sup>(1)</sup>Pulse width limited by safe operating area<sup>(2)</sup>Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

Table 9: Gate-source Zener diode

| Symbol        | Parameter                     | Test conditions                                 | Min.     | Typ. | Max. | Unit |
|---------------|-------------------------------|-------------------------------------------------|----------|------|------|------|
| $V_{(BR)GSO}$ | Gate-source breakdown voltage | $I_{GS} = \pm 1\text{ mA}$ , $I_D = 0\text{ A}$ | $\pm 30$ | -    | -    | V    |

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

## 2.1 Electrical characteristics (curves)

Figure 2: Safe operating area

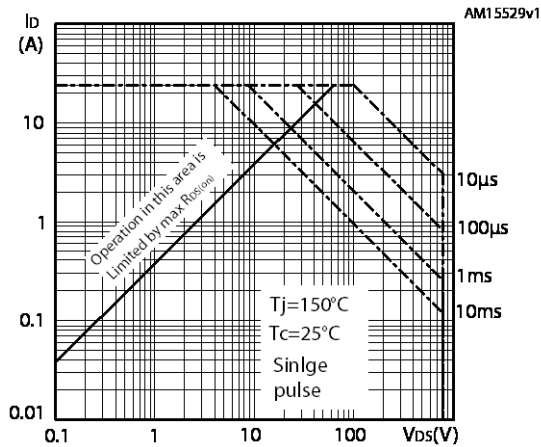


Figure 3: Thermal impedance

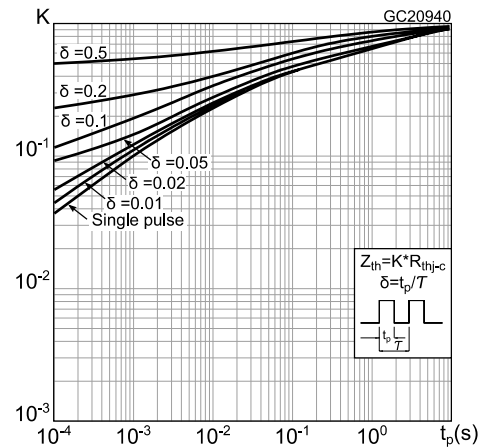


Figure 4: Output characteristics

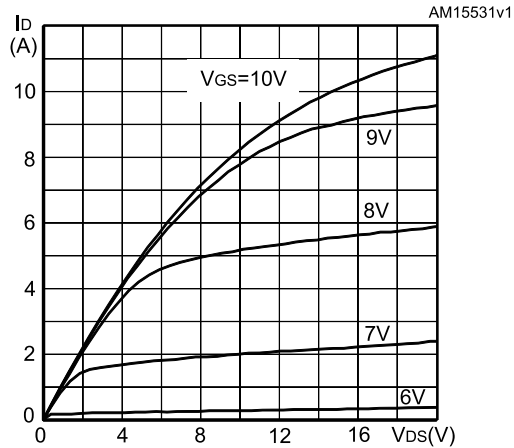


Figure 5: Transfer characteristics

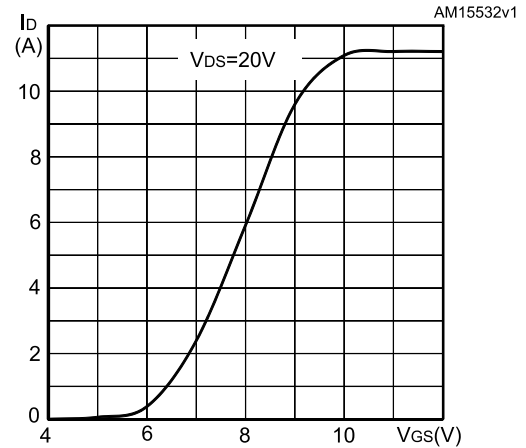


Figure 6: Gate charge vs gate-source voltage

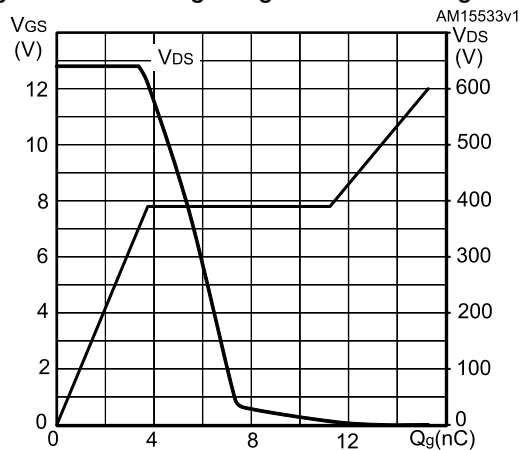


Figure 7: Static drain-source on-resistance

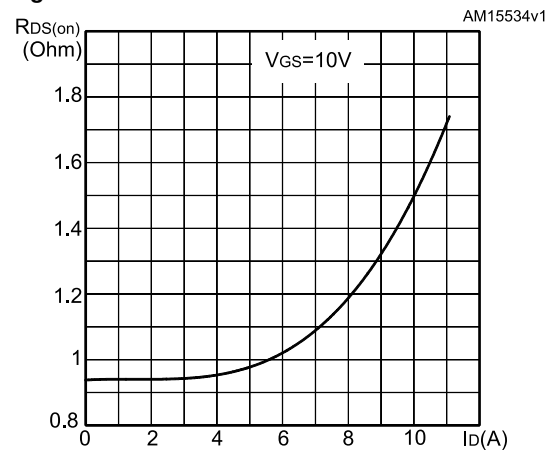


Figure 8: Capacitance variations

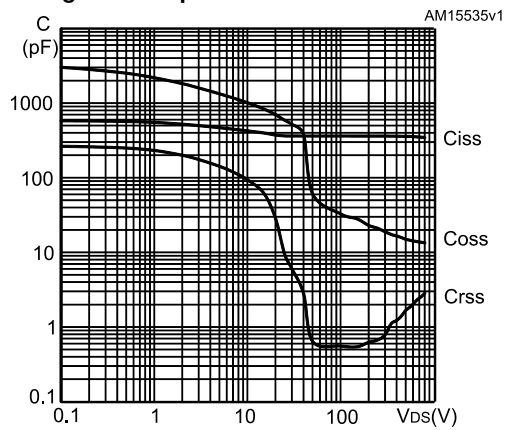


Figure 9: Output capacitance stored energy

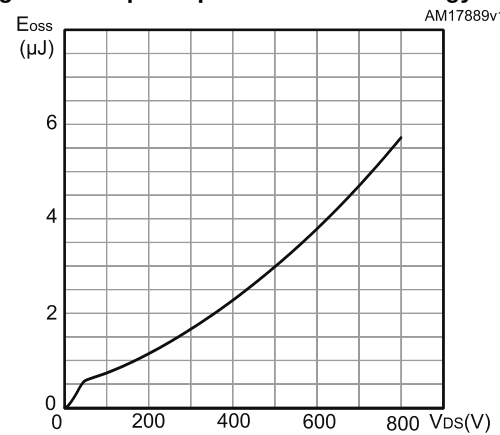


Figure 10: Normalized gate threshold voltage vs temperature

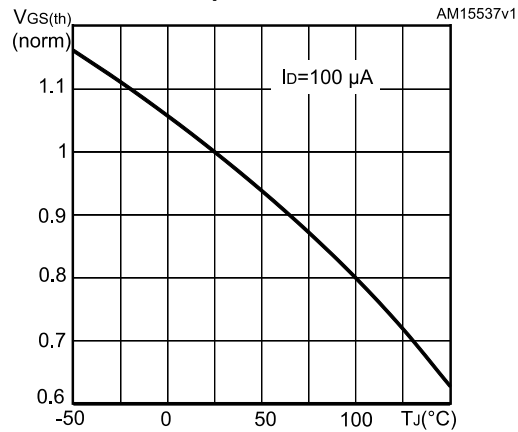


Figure 11: Normalized on-resistance vs temperature

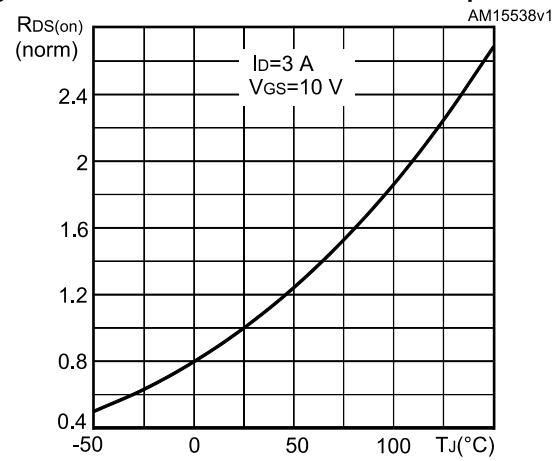


Figure 12: Normalized V(BR)DSS vs temperature

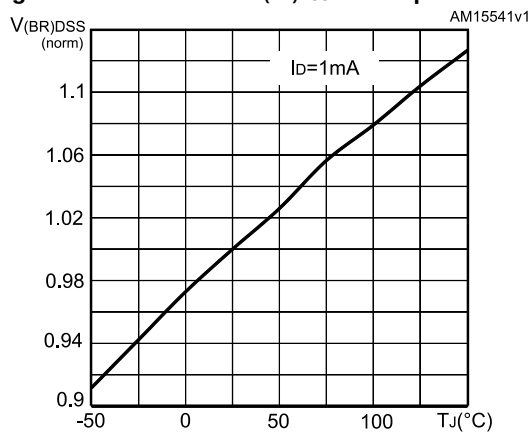


Figure 13: Maximum avalanche energy vs starting Tj

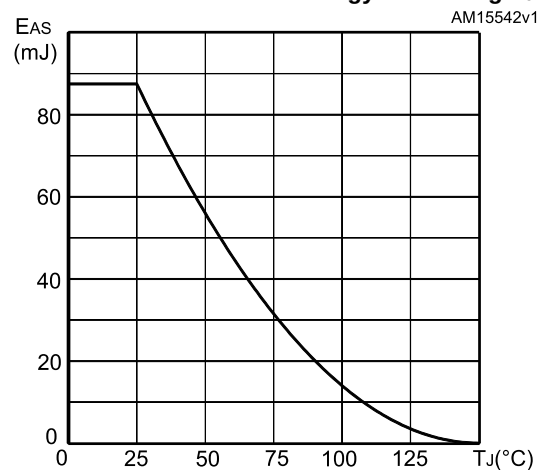
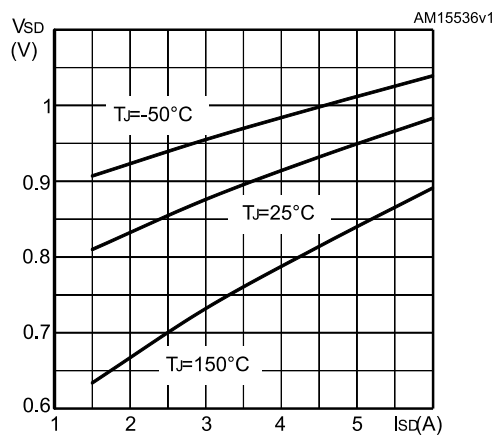


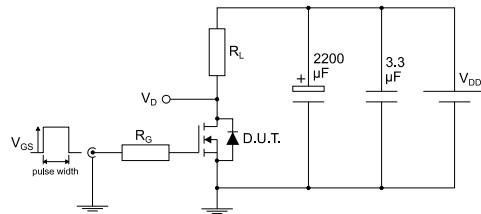
Figure 14: Source-drain diode forward characteristics





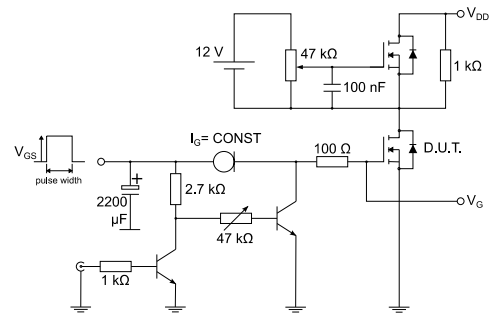
### 3 Test circuits

**Figure 15: Test circuit for resistive load switching times**



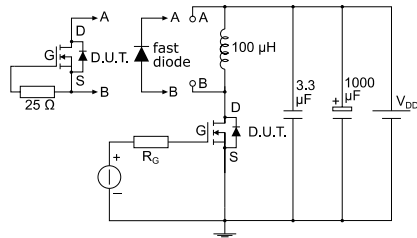
AM01468v1

**Figure 16: Test circuit for gate charge behavior**



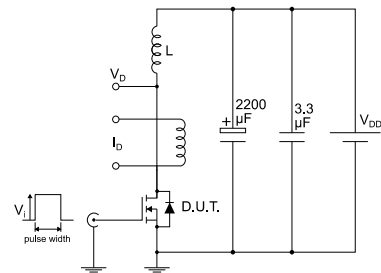
AM01469v1

**Figure 17: Test circuit for inductive load switching and diode recovery times**



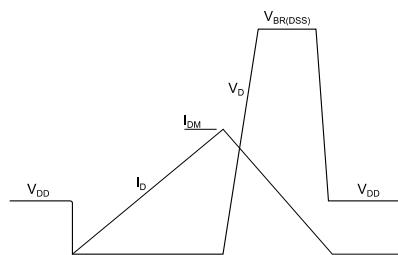
AM01470v1

**Figure 18: Unclamped inductive load test circuit**



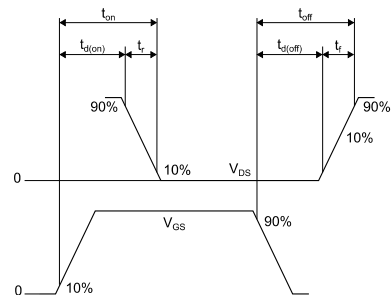
AM01471v1

**Figure 19: Unclamped inductive waveform**



AM01472v1

**Figure 20: Switching time waveform**



AM01473v1

## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **[www.st.com](http://www.st.com)**. ECOPACK® is an ST trademark.

## 4.1 TO-220FP package information

Figure 21: TO-220FP package outline

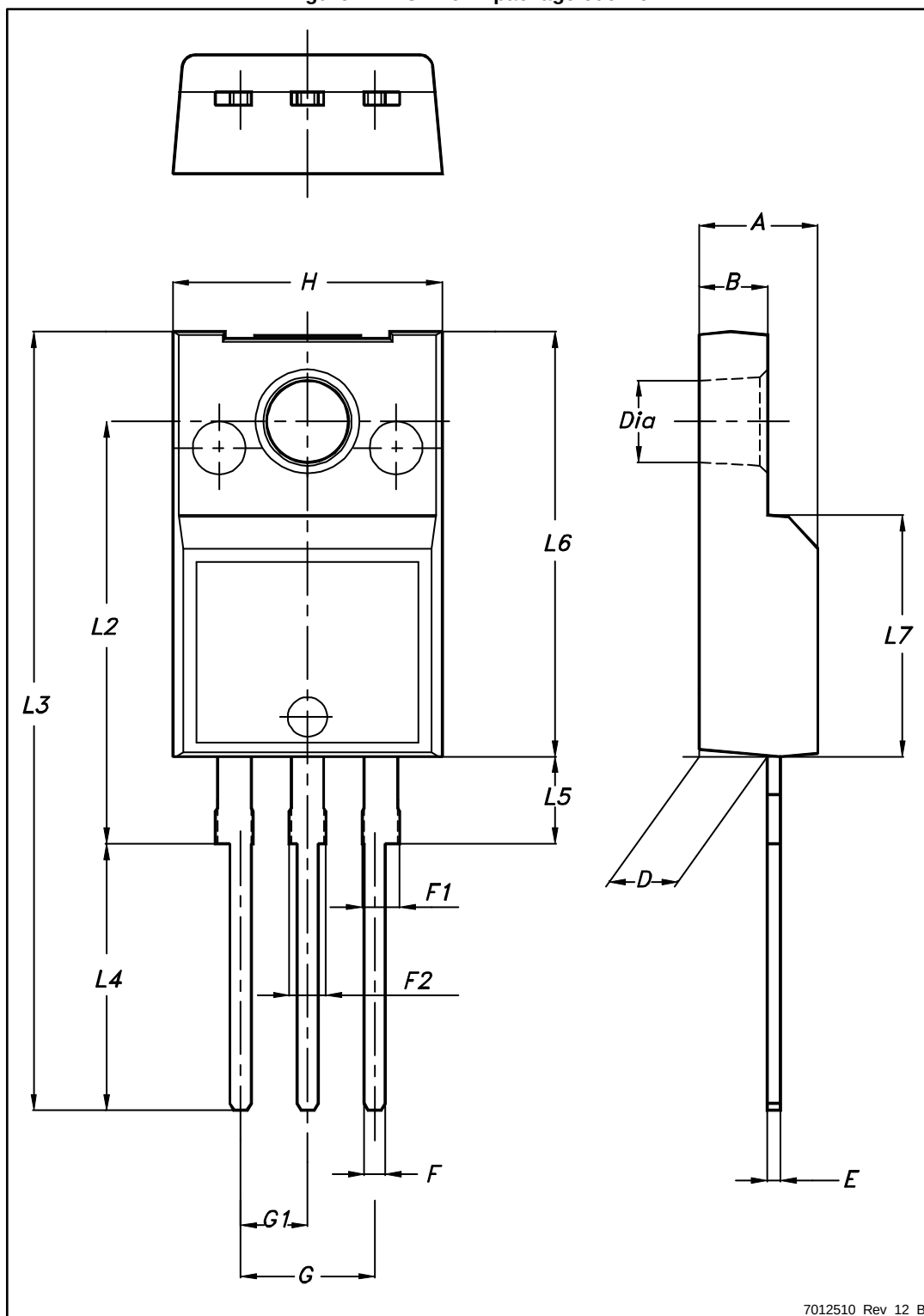


Table 10: TO-220FP package mechanical data

| Dim. | mm   |      |      |
|------|------|------|------|
|      | Min. | Typ. | Max. |
| A    | 4.4  |      | 4.6  |
| B    | 2.5  |      | 2.7  |
| D    | 2.5  |      | 2.75 |
| E    | 0.45 |      | 0.7  |
| F    | 0.75 |      | 1    |
| F1   | 1.15 |      | 1.70 |
| F2   | 1.15 |      | 1.70 |
| G    | 4.95 |      | 5.2  |
| G1   | 2.4  |      | 2.7  |
| H    | 10   |      | 10.4 |
| L2   |      | 16   |      |
| L3   | 28.6 |      | 30.6 |
| L4   | 9.8  |      | 10.6 |
| L5   | 2.9  |      | 3.6  |
| L6   | 15.9 |      | 16.4 |
| L7   | 9    |      | 9.3  |
| Dia  | 3    |      | 3.2  |

## 4.2 I<sup>2</sup>PAKFP (TO-281) package information

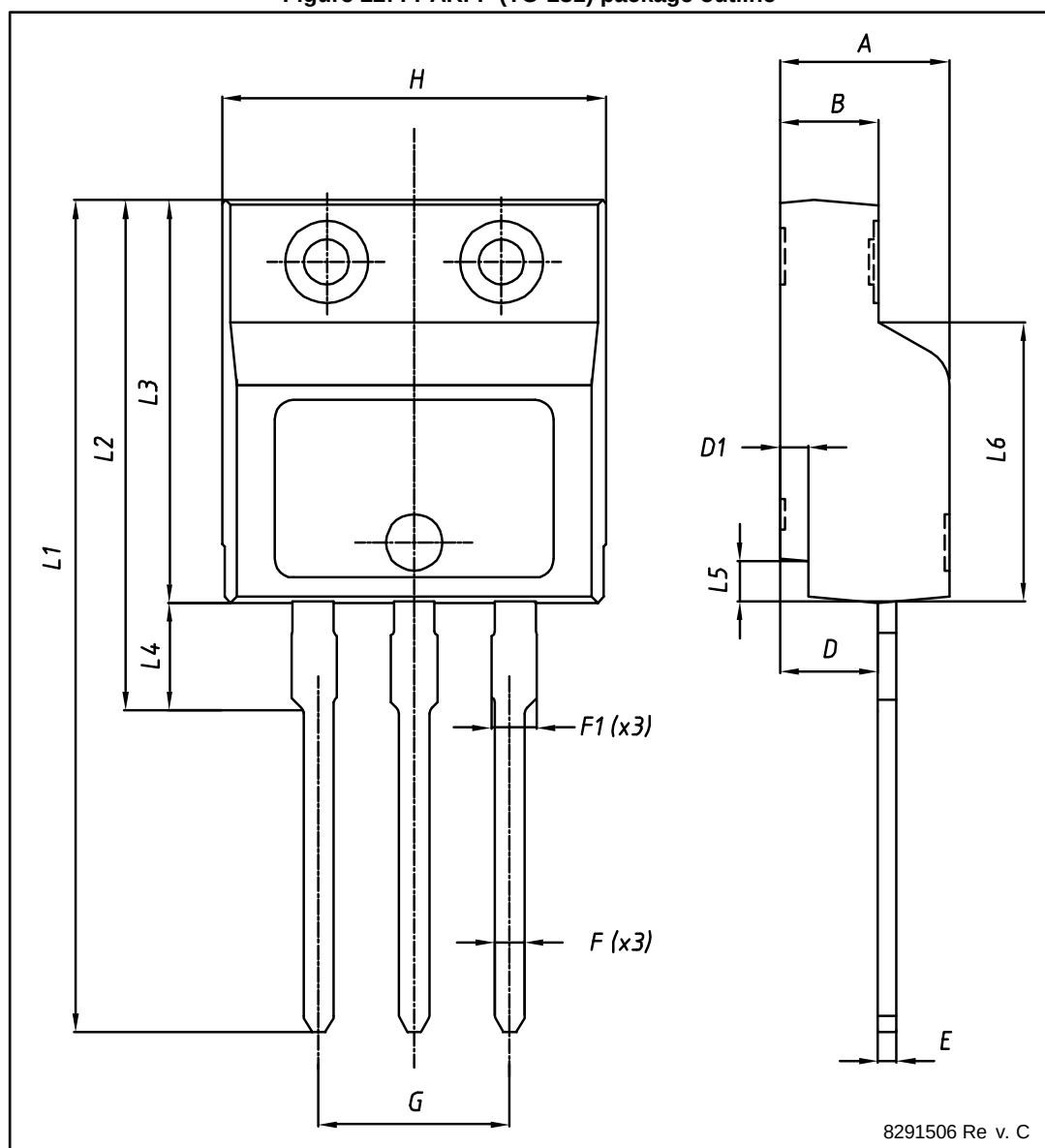
Figure 22: I<sup>2</sup>PAKFP (TO-281) package outline

Table 11: I<sup>2</sup>PAKFP (TO-281) mechanical data

| Dim. | mm    |      |       |
|------|-------|------|-------|
|      | Min.  | Typ. | Max.  |
| A    | 4.40  |      | 4.60  |
| B    | 2.50  |      | 2.70  |
| D    | 2.50  |      | 2.75  |
| D1   | 0.65  |      | 0.85  |
| E    | 0.45  |      | 0.70  |
| F    | 0.75  |      | 1.00  |
| F1   |       |      | 1.20  |
| G    | 4.95  |      | 5.20  |
| H    | 10.00 |      | 10.40 |
| L1   | 21.00 |      | 23.00 |
| L2   | 13.20 |      | 14.10 |
| L3   | 10.55 |      | 10.85 |
| L4   | 2.70  |      | 3.20  |
| L5   | 0.85  |      | 1.25  |
| L6   | 7.50  | 7.60 | 7.70  |

## 5 Revision history

**Table 12: Document revision history**

| Date        | Revision | Changes                                                                                                                                                                                                                       |
|-------------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 11-Oct-2013 | 1        | First release. Part numbers previously included in datasheet DocID023448                                                                                                                                                      |
| 05-Jul-2017 | 2        | Modified features on cover page.<br>Modified <a href="#">Table 2: "Absolute maximum ratings"</a> , <a href="#">Table 7: "Switching times"</a> and <a href="#">Table 9: "Gate-source Zener diode"</a> .<br>Minor text changes. |

**IMPORTANT NOTICE – PLEASE READ CAREFULLY**

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2017 STMicroelectronics – All rights reserved